

# THERMOMECHANICAL MEASUREMENTS FOR ENERGY SYSTEMS

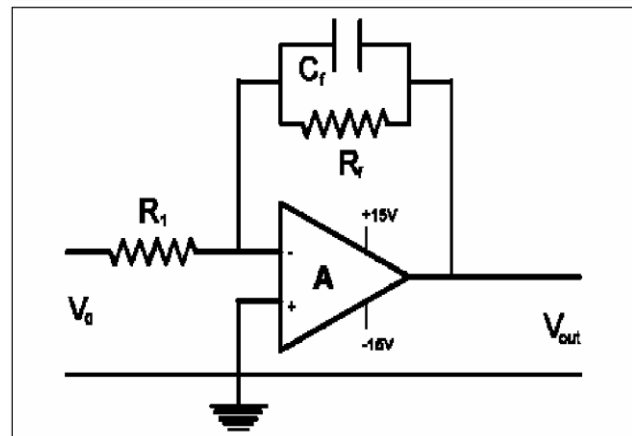
MENR (A.A. 2017-2018)

## Laboratory n. 3

A digital acquisition system is made of a PC pentium dual core, with a data acquisition board (NI 6052E) and a terminal unit (NI ELVIS) to generate and acquire analog signals and digital data.

The system is programmed by a dedicated software (LabView 8.2™) to generate an output signal and to acquire input data at the same time. On the breadboard, the prototype board of the terminal unit, an amplified RC filter is assembled, as shown in the figure below.

1. Generate a sine signal to input to the active filter (RC) with whatever frequency. Look at the waveform on the screen, define which output ( $f_{D/A}$ ) and input ( $f_{A/D}$ ) sample frequencies to the system are correct for the selected signal.
2. Define the gain  $G$  and the cut off frequency  $f_t$  of the dynamic filter. Change the input signal frequency to the filter, define which sample frequency (minimum) is correct at the filter's cut-off frequency  $f_t$ , both for the generated signal ( $f_{D/A}$ ) and for the acquired one ( $f_{A/D}$ ).



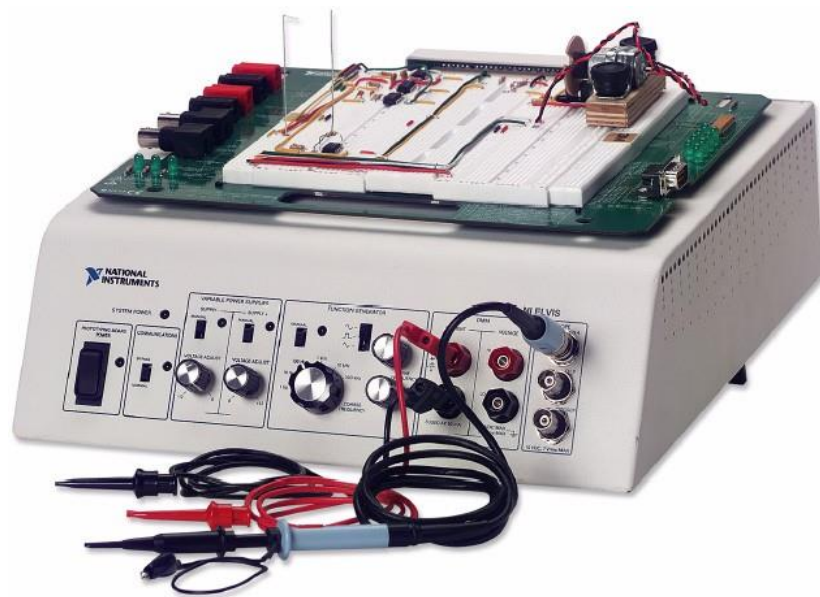
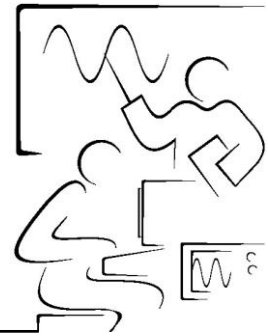
3. Verify the % difference between the theoretical  $f_t$  and the theoretical gain  $G$  of the filter and the values acquired experimentally, bearing in mind the filter's cut-off frequency is equal to  $f_t = \frac{1}{2\pi R_f C_f}$  instead the transfer function (gain + frequency response) is  $\frac{V_{out}}{V_{in}} = -\frac{R_f}{R_1} \times \frac{1}{1+j\omega R_f C_f}$  with  $R_1 = 2,2 \text{ k}\Omega$ ;  $R_f = 10 \text{ k}\Omega$ ;  $C_f = 0.1 \text{ }\mu\text{F}$  (nominal values).
4. Using as input signal a square wave, define the frequency band for which the dynamic RC filter works correctly as “signal integrator” and with which sample frequencies  $f_{D/A}$  and  $f_{A/D}$  of the Digital/Analog and Analog/Digital converters, respectively.

( Attachments: NI ELVIS introductory flyer; Amp Op UA741CN data sheet )

# Lab 1

## NI ELVIS

### Workspace Environment



The NI ELVIS environment consists of the hardware workspace for building circuits and interfacing experiments, and the NI ELVIS software. The NI ELVIS software, all created in LabVIEW has two main types: the soft front panel (SFP) instruments and LabVIEW APIs, which are just additional LabVIEW VIs for custom control and access to the features of the NI ELVIS benchtop workstation.

## Goal

This lab introduces the NI ELVIS workstation to show how electronic component properties can be measured. Circuits are then built on the protoboard and later analyzed with the NI ELVIS software suite of LabVIEW based soft front panels (SFP) or software instruments. In addition, this experiment demonstrates the use of NI ELVIS within a LabVIEW programming environment.



# UA741

## GENERAL PURPOSE SINGLE OPERATIONAL AMPLIFIER

- LARGE INPUT VOLTAGE RANGE
- NO LATCH-UP
- HIGH GAIN
- SHORT-CIRCUIT PROTECTION
- NO FREQUENCY COMPENSATION REQUIRED
- SAME PIN CONFIGURATION AS THE UA709

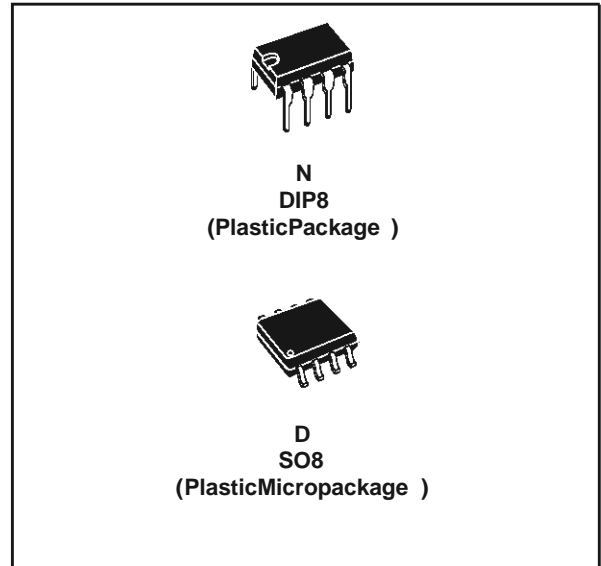
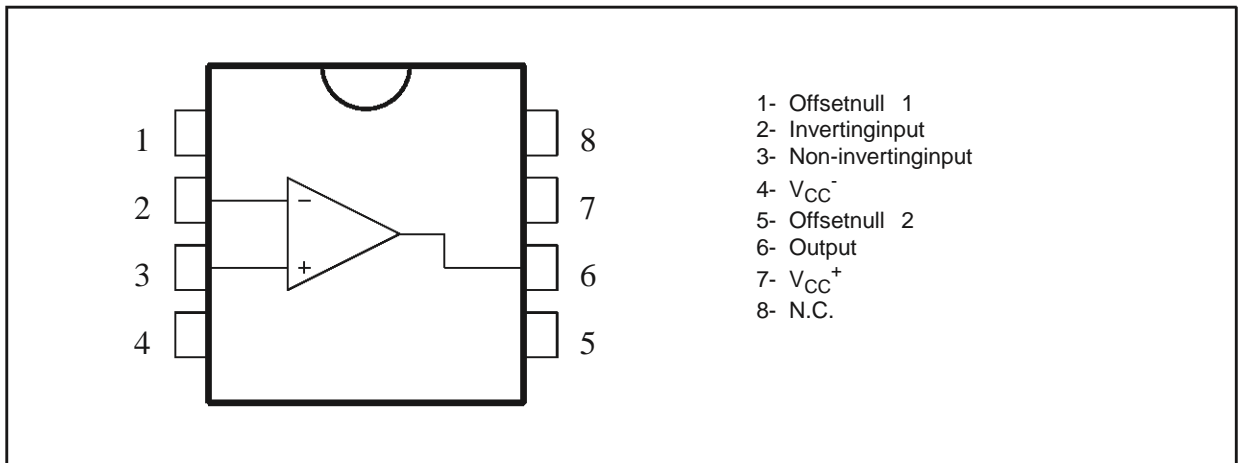
### DESCRIPTION

The UA741 is a high performance monolithic operational amplifier constructed on a single silicon chip. It is intended for a wider range of analog applications.

- Summing amplifier
- Voltage follower
- Integrator
- Active filter
- Function generator

The high gain and wide range of operating voltages provides superior performance in integrator, summing amplifier and general feedback applications. The internal compensation network (6dB/octave) insures stability in closed loop circuits.

### PIN CONNECTIONS (top view)



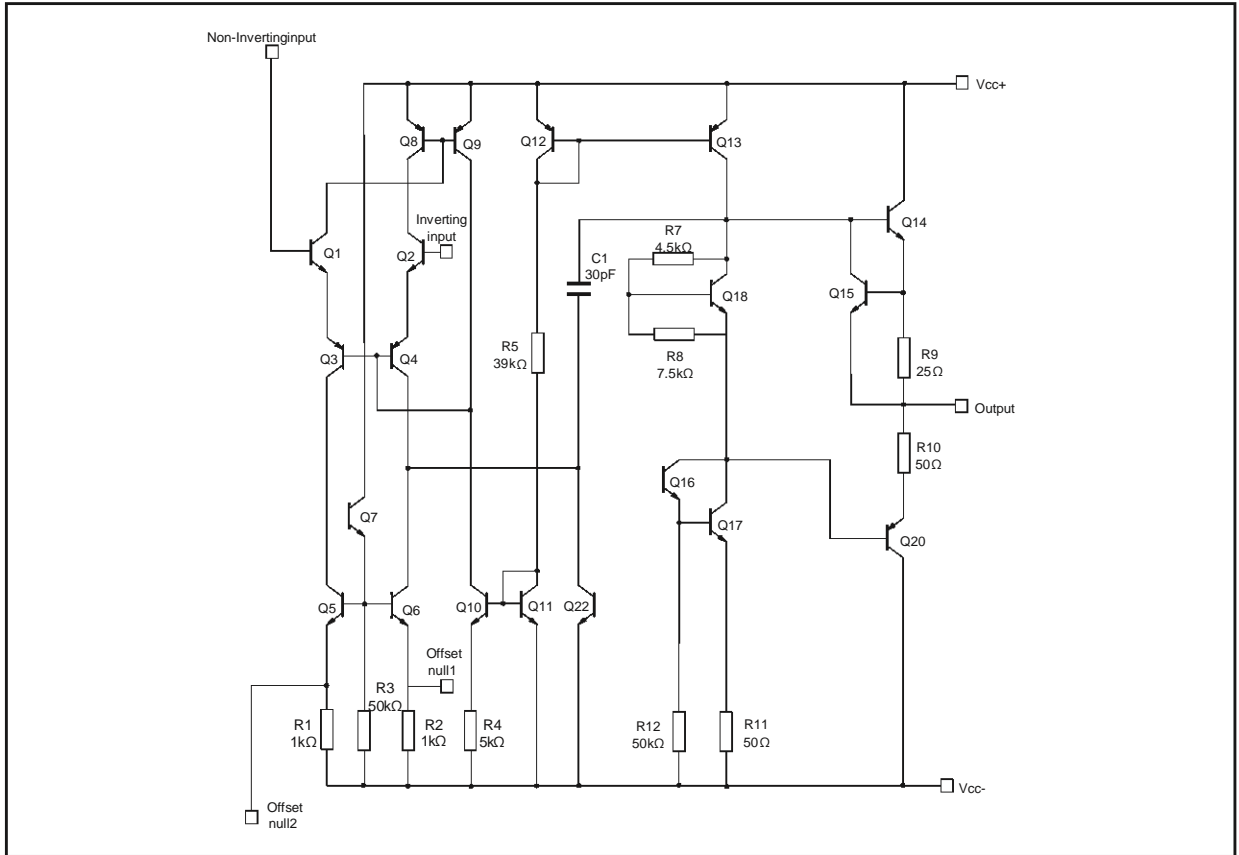
### ORDER CODE

| Part Number | Temperature Range | Package |   |
|-------------|-------------------|---------|---|
|             |                   | N       | D |
| UA741C      | 0°C, +70 °C       | •       | • |
| UA741I      | -40°C, +105 °C    | •       | • |
| UA741M      | -55°C, +125 °C    | •       | • |

**Example:** UA741CN

N= Dual in Line Package (DIP)  
D= Small Outline Package (SO)-also available in Tape & Reel (DT)

**SCHEMATICDIAGRAM**



**ABSOLUTE MAXIMUM RATINGS**

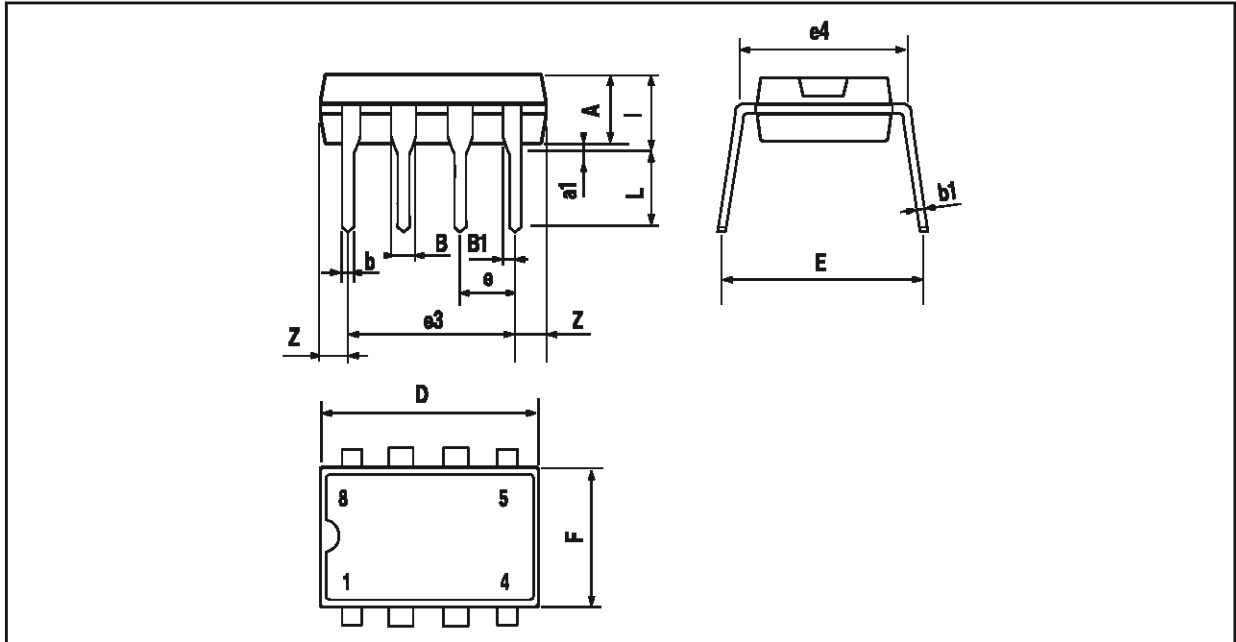
| Symbol     | Parameter                            | UA741M      | UA741I      | UA741C   | Unit        |
|------------|--------------------------------------|-------------|-------------|----------|-------------|
| $V_{CC}$   | Supply voltage                       |             | $\pm 22$    |          | V           |
| $V_{id}$   | Differential Input Voltage           |             | $\pm 30$    |          | V           |
| $V_i$      | Input Voltage                        |             | $\pm 15$    |          | V           |
| $P_{tot}$  | Power Dissipation <sup>1)</sup>      |             | 500         |          | mW          |
|            | Output Short-circuit Duration        |             | Infinite    |          |             |
| $T_{oper}$ | Operating Free-air Temperature Range | -55 to +125 | -40 to +105 | 0 to +70 | $^{\circ}C$ |
| $T_{stg}$  | Storage Temperature Range            |             | -65 to +150 |          | $^{\circ}C$ |

1. Power dissipation must be considered to ensure maximum junction temperature ( $T_j$ ) is not exceeded.



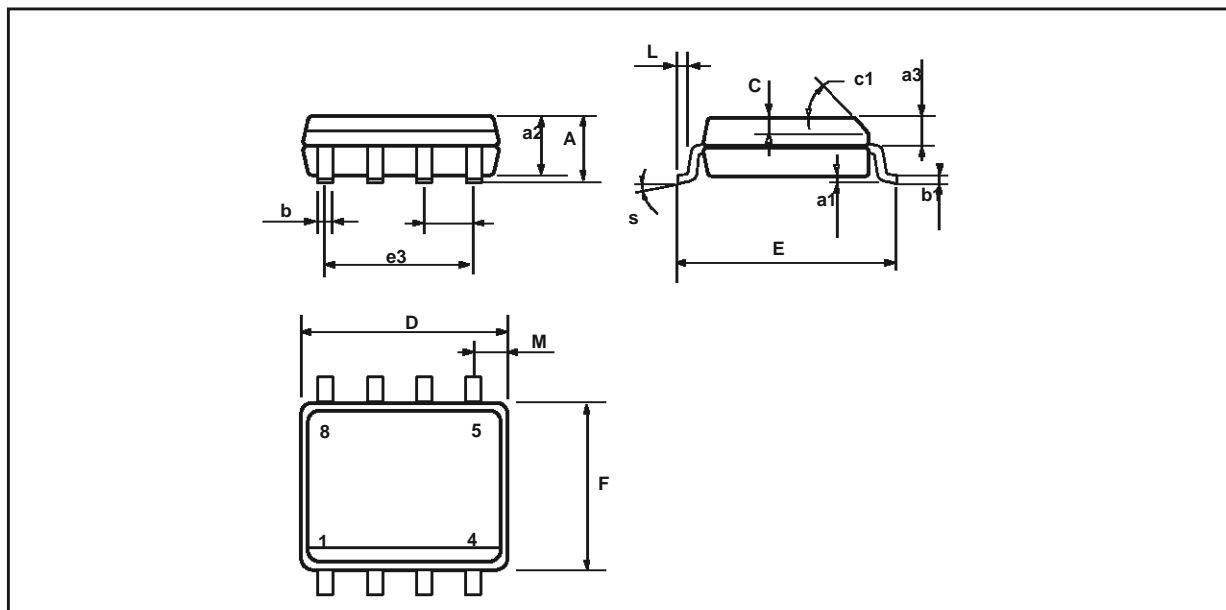
# UA741

## PACKAGE MECHANICAL DATA 8 PINS-PLASTIC DIP



| Dim. | Millimeters |      |       | Inches |       |       |
|------|-------------|------|-------|--------|-------|-------|
|      | Min.        | Typ. | Max.  | Min.   | Typ.  | Max.  |
| A    |             | 3.32 |       |        | 0.131 |       |
| a1   | 0.51        |      |       | 0.020  |       |       |
| B    | 1.15        |      | 1.65  | 0.045  |       | 0.065 |
| b    | 0.356       |      | 0.55  | 0.014  |       | 0.022 |
| b1   | 0.204       |      | 0.304 | 0.008  |       | 0.012 |
| D    |             |      | 10.92 |        |       | 0.430 |
| E    | 7.95        |      | 9.75  | 0.313  |       | 0.384 |
| e    |             | 2.54 |       |        | 0.100 |       |
| e3   |             | 7.62 |       |        | 0.300 |       |
| e4   |             | 7.62 |       |        | 0.300 |       |
| F    |             |      | 6.6   |        |       | 0.260 |
| i    |             |      | 5.08  |        |       | 0.200 |
| L    | 3.18        |      | 3.81  | 0.125  |       | 0.150 |
| Z    |             |      | 1.52  |        |       | 0.060 |

**PACKAGE MECHANICAL DATA**  
 8 PINS-PLASTIC MICROPACKAGE (SO )



| Dim. | Millimeters |      |      | Inches |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Min.        | Typ. | Max. | Min.   | Typ.  | Max.  |
| A    |             |      | 1.75 |        |       | 0.069 |
| a1   | 0.1         |      | 0.25 | 0.004  |       | 0.010 |
| a2   |             |      | 1.65 |        |       | 0.065 |
| a3   | 0.65        |      | 0.85 | 0.026  |       | 0.033 |
| b    | 0.35        |      | 0.48 | 0.014  |       | 0.019 |
| b1   | 0.19        |      | 0.25 | 0.007  |       | 0.010 |
| C    | 0.25        |      | 0.5  | 0.010  |       | 0.020 |
| c1   | 45° (typ.)  |      |      |        |       |       |
| D    | 4.8         |      | 5.0  | 0.189  |       | 0.197 |
| E    | 5.8         |      | 6.2  | 0.228  |       | 0.244 |
| e    |             | 1.27 |      |        | 0.050 |       |
| e3   |             | 3.81 |      |        | 0.150 |       |
| F    | 3.8         |      | 4.0  | 0.150  |       | 0.157 |
| L    | 0.4         |      | 1.27 | 0.016  |       | 0.050 |
| M    |             |      | 0.6  |        |       | 0.024 |
| S    | 8° (max.)   |      |      |        |       |       |

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